

LTC2997

Remote/Internal Temperature Sensor

- Converts Remote Sensor or Internal Diode **Temperature to Analog Voltage**
- **±1°C Remote Temperature Accuracy**
- ±1.5°C Internal Temperature Accuracy
- ⁿ **Built-In Series Resistance Cancellation**
- \blacksquare 2.5V to 5.5V Supply Voltage
- 1.8V Reference Voltage Output
- 3.5ms V_{PTAT} Update Time
- 4mV/°K Output Gain
- 170µA Quiescent Current
- Available in 6-Pin $2mm \times 3mm$ DFN Package

APPLICATIONS

- \blacksquare Temperature Measurement
- Remote Temperature Measurement
- **Environmental Monitoring**
- System Thermal Control
- Desktop and Notebook Computers
- Network Servers

FEATURES DESCRIPTION

The LTC®2997 is a high-accuracy analog output temperature sensor. It converts the temperature of an external sensor or its own temperature to an analog voltage output. A built-in algorithm eliminates errors due to series resistance between the LTC2997 and the sensor diode.

The LTC2997 gives accurate results with low-cost diodeconnected NPN or PNP transistors or with integrated temperature transistors on microprocessors or FPGAs. Tying pin D^+ to V_{CC} configures the LTC2997 to measure its internal temperature.

The LTC2997 provides an additional 1.8V reference voltage output which can be used as an ADC reference input or for generating temperature threshold voltages to compare against the V_{PTAT} output.

The LTC2997 provides a precise and versatile micropower solution for accurate temperature sensing.

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TYPICAL APPLICATION

VPTAT vs Remote Sensor Temperature

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ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2)

Terminal Voltages

Operating Ambient Temperature Range

PIN CONFIGURATION

ORDER INFORMATION

Lead Free Finish

TRM = 500 pieces. *Temperature grades are identified by a label on the shipping container.

Consult LTC Marketing for parts specified with wider operating temperature ranges.

Consult LTC Marketing for information on lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating

temperature range, otherwise specifications are at T_A = 25°C, V_{CC} = 3.3V, unless otherwise noted.

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: All currents into pins are positive; all voltages are referenced to GND unless otherwise noted.

Note 3: If voltage on pin D⁺ exceeds the diode select threshold the LTC2997 uses the internal diode sensor.

Note 4: η = ideality factor of remote diode

Note 5: Remote diode temperature.

Note 6: Guaranteed by design and not subject to test.

Note 7: Guaranteed by design and test correlation.

TYPICAL PERFORMANCE CHARACTERISTICS

 $T_A = 25^{\circ}$ C, $V_{CC} = 3.3V$ unless otherwise noted.

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Supply Current vs Temperature

LTC2997 Internal Sensor Thermal Step Response

Remote Temperature Error vs Leakage Current at D+ with Remote Diode at 25°C, T_{RMT}

PIN FUNCTIONS

D⁺: Diode Sense Current Source. D⁺ sources the remote diode sensing current. Connect D^+ to the anode of the remote sensor device. It is recommended to connect a 470pF bypass capacitor between D^+ and D^- . Larger capacitors may cause settling time errors (see Typical Performance Characteristics). If D⁺ is tied to V_{CC} , the LTC2997 measures the internal sensor temperature. Tie D^+ to V_{CC} if unused.

D⁻: Diode Sense Current Sink. Connect D⁻ to the cathode of the remote sensor device. Tie D^- to GND for single wire remote sensing (see Typical Applications) or internal temperature sensing.

GND: Device Ground.

V_{CC}: Supply Voltage. Bypass this pin to GND with a 0.1μF (or greater) capacitor. V_{CC} operating range is 2.5V to 5.5V.

VPTAT: V_{PTAT} Voltage Output. The voltage on this pin is proportional to the sensor's absolute temperature. V_{PTAT} can drive a capacitive load of up to 1000pF. For larger load capacitance, insert 1kΩ between V_{PTAT} and load to guarantee stability. V_{PTAT} can drive up to $\pm 200\mu$ A of load current. V_{PTAT} is pulled low when the supply voltage goes below the under voltage lockout threshold.

VREF: Voltage Reference Output. V_{REF} provides a 1.8V reference voltage. V_{RFF} can drive a capacitive load of up to 1000pF. For larger load capacitance, insert 1kΩ between V_{REF} and load to guarantee stability. V_{REF} can drive up to $±200\mu A$ of load current. Leave V_{RFF} open if unused.

Exposed Pad: Exposed pad may be left open or soldered to GND for better thermal coupling.

BLOCK DIAGRAM

2997fa

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OPERATION

The Block Diagram shows the main components of the LTC2997.

The LTC2997 measures temperature using either a remote or internal diode and provides a buffered voltage proportional to absolute temperature (V_{PTAT}) and a buffered 1.8V reference voltage. Remote temperature measurements usually use a diode connected transistor as a temperature sensor, allowing the remote sensor to be a discrete NPN (ex. MMBT3904) or an embedded PNP device in a microprocessor or FPGA.

Temperature measurements are conducted by measuring the diode voltage at multiple test currents. The diode equation can be solved for T, where T is degrees Kelvin, I_S is a process dependent factor on the order of 10⁻¹³A, η is the diode ideality factor, k is the Boltzmann constant and q is the electron charge:

$$
T = \frac{q}{\eta \cdot k} \cdot \frac{V_{\text{DIODE}}}{\ln\left(\frac{I_D}{I_S}\right)}
$$

This equation has a relationship between temperature and voltage, dependent on the process-dependent variable I_S. Measuring the same diode (with the same value I_S) at two different currents yields an expression which is independent of I_S . The value in the natural logarithm term becomes the ratio of the two currents, which is process independent.

$$
T = \frac{q}{\eta \cdot k} \cdot \frac{V_{DIODE2} - V_{DIODE1}}{\ln \left(\frac{I_{D2}}{I_{D1}}\right)}
$$

Series Resistance Cancellation

Resistance in series with the remote diode causes a positive temperature error by increasing the measured voltage at each test current. The composite voltage equals:

$$
V_{DIODE} + V_{ERROR} = \eta \frac{kT}{q} \cdot \ln \left(\frac{I_D}{I_S} \right) + R_S \cdot I_D
$$

where R_S is the series resistance.

The LTC2997 removes this error term from the sensor signal by subtracting a cancellation voltage (see Figure 1). A resistance extraction circuit uses one additional current (I_3) to determine the series resistance in the measurement path. Once the correct value of the resistor is determined V_{CANCEL} equals V_{ERROR}. Now the temperature to voltage converter's input signal is free from errors due to series resistance and the sensor temperature can be determined using currents I_1 and I_2 .

Figure 1. Series Resistance Cancellation

APPLICATIONS INFORMATION

Power Up and UVLO

The basic LTC2997 application using an external NPN transistor is shown in Figure 2.

Figure 2. Basic Application Circuit

The V_{CC} pin must exceed the undervoltage threshold of 1.9V (typical) for normal operation. For V_{CC} below UVLO the LTC2997 enters power-on reset and V_{PTAT} is pulled low.

Temperature Measurements

Before each conversion a voltage comparator connected to D+ automatically sets the LTC2997 into external or internal mode. Tying D^+ to V_{CC} enables internal mode and V_{PTAT} represents the die temperature. The V_{PTAT} gain, K_T , is 4mV/K. The temperature in Kelvin is easily calculated:

$$
T_{KELVIN} = \frac{V_{PTAT}}{K_T}
$$

For V_{D+} more than 300mV below V_{CC} (typical) the LTC2997 assumes that an external sensor is connected and will start sending sensing currents to the remote sensor diode. The anode of the external sensor must be connected to pin D+. The cathode should be connected to D^- for best external noise immunity. For single wire measurements the sensor cathode is connected to remote GND and D⁻ must be connected to local GND (see Figure 7). Small ground DC voltages (<±200mV) between the two cathode potentials do not impact the measurement accuracy. AC voltages at odd multiples of 6kHz (±20%) cause temperature measurement errors (see Typical Performance Characteristics). The LTC2997 is calibrated to yield a V_{PTAT} gain of 4mV/K for a remote diode with an ideality factor of 1.004. A built-in algorithm cancels errors due to series resistance

of up to 100Ω to an error smaller than 1 $°C$ (see Typical Performance Characteristics). The LTC2997 continuously measures the sensor diode at different test currents and updates V_{PTAT} every 3.5ms (typical).

Input Noise Filtering

The change in sensor voltage per °C is hundreds of microvolts, so electrical noise must be kept to a minimum. Bypass D+ and D– with a 470pF capacitor close to the LTC2997 to suppress external noise. Bypass capacitors greater 1nF cause settling time errors of the different measurement currents. See Typical Performance Characteristics. Long wires connecting external sensors add series resistance, mutual capacitance between D⁺ and D⁻, and cause leakage currents. A 10m CAT6 cable has ~500pF of mutual capacitance and adds negligible series resistance and leakage currents. Recommended shielding and PCB trace considerations for best noise immunity are illustrated in Figure 3.

Figure 3. Recommended PCB Layout

Output Noise Filtering

The V_{PTAT} output typically exhibits 1mV RMS (0.25 \degree C RMS) noise. For applications which require lower noise digital or analog averaging can be applied to the output. Choose the averaging time according to the following equation:

$$
t_{AVG} = \left(\frac{0.015\left[\text{°C}/\sqrt{\text{Hz}}\right]}{T_{NOISE}}\right)^2
$$

where t_{AVG} is the averaging time and T_{NOISE} the desired temperature noise in °C RMS. For example, if the desired noise performance is 0.015°C RMS, set the averaging time to one second. See Typical Performance Characteristics.

APPLICATIONS INFORMATION

Choosing a Sensor

The LTC2997 is factory calibrated for an ideality factor of 1.004, which is typical of the popular MMBT3904 NPN transistor. Semiconductor purity and wafer-level processing intrinsically limit device-to-device variation, making these devices interchangeable between most manufacturers with a temperature error of typically less than 0.5°C. Some recommended sources are listed in Table 1:

Table 1. Recommended Transistors for Use as Temperature Sensors.

Discrete two terminal diodes usually have ideality factors significantly higher than 1.004 and are therefor not recommended as remote sensing devices.

Protection

The LTC2997 can withstand up to $±4kV$ of electrostatic discharge (ESD, human body). ESD beyond this voltage can damage or degrade the device including lowering the remote sensor measurement accuracy due to increased leakage currents on D^+ and D^- .

To protect the sensing inputs against larger ESD strikes, external protection can be added using TVS diodes to ground (Figure 4). Care must be taken to choose diodes with low capacitance and low leakage currents in order not to degrade the external sensor measurement accuracy (see Typical Performance Characteristics).

Figure 4. Increasing ESD Robustness with TVS Diodes

Ideality Factor Scaling

While an ideality factor value of 1.004 is typical of many sensor devices, small deviations can yield significant temperature errors. The ideality factor acts as a temperature scaling factor. The temperature error for a 1% deviation is 1% of the Kelvin temperature. Thus, at 25°C (298K) a +1% accurate ideality factor error yields a +2.98 degree error. At 85°C (358K) a +1% error yields a 3.58 degree error. It is possible to scale the PTAT voltage if an external sensor with an ideality factor other than 1.004 is used. The scaling equation for the compensated PTAT voltage is listed below.

LTC2997 Ideality Calibration Value:

 $\eta_{CAL} = 1.004$

Actual Remote Sensor Ideality Value:

ηACT

Compensated PTAT Voltage:

$$
V_{PTAT_COMP}=\frac{\eta_{CAL}}{\eta_{ ACT}}\bullet V_{PTAT_MEAS}
$$

Compensated Kelvin Temperature:

$$
T_{KELVIN_COMP}=\frac{\eta_{CAL}}{\eta_{ACT}}\bullet T_{KELVIN_MEAS}
$$

Compensated Celsius Temperature:

$$
T_{CELSIUS_COMP} = \frac{\eta_{CAL}}{\eta_{ ACT}} \cdot (T_{KELVIN_MEAS}) - 273.15
$$

Figure 5. Single Remote Temperature Sensor

Figure 6. Internal Temperature Sensor

Figure 7. Remote CPU Temperature Sensor

Figure 8. Single Wire Remote Temperature Sensor

Figure 9. Output Noise Filter

Figure 10. Long Distance Remote Temperature Sensor

Figure 11. Analog PWM Heater Controller

Figure 12. 75°C Analog Heater Controller

Figure 13. Remote Diode Sensor Insensitive to Cable Connection Polarity

Figure 14. Temperature Proportional PWM Fan Speed Controller

PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.

DCB Package 6-Lead Plastic DFN (2mm × **3mm)**

RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS

1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (TBD)

2. DRAWING NOT TO SCALE

3. ALL DIMENSIONS ARE IN MILLIMETERS

4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE

- MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE 5. EXPOSED PAD SHALL BE SOLDER PLATED
- 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE

TOP AND BOTTOM OF PACKAGE

REVISION HISTORY

